1-746611-0 - ACTIVE

AMP-LATCH

TE Internal #: 1-746611-0 Ribbon Cable Connectors, Wire-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Vertical, Through Hole - Solder, 2 Row, Plug, Standard Profile

View on TE.com >

Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Wire-to-Board

Number of Positions: 20

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Retention: Without

PCB Mount Orientation: Vertical

Features

TE

Product Type Features

Ribbon Cable Connector Header Type	Pin Header	
Connector Product Type	Connector Assembly	
Connector System	Wire-to-Board	
Connector & Housing Type	Plug	
Connector & Contact Terminates To	Printed Circuit Board, Wire & Cable	
Configuration Features		
Number of Positions	20	
PCB Mount Orientation	Vertical	
Number of Rows	2	
Electrical Characteristics		
Insulation Resistance	5000 MΩ	
Operating Voltage	250 VAC	
Body Features		
Daisy Chain	Without	

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Primary Product Color	Black	
Connector Profile	Standard	
Contact Features		
PCB Contact Termination Area Plating Material Thickness	.762 μm[30 μin]	
Contact Layout	Inline	
Contact Type	Pin	
Wire Contact Termination Area Plating Thickness	.127 μm[5 μin]	
Wire Contact Termination Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]	
PCB Contact Termination Area Plating Material	Gold	
Contact Base Material	Phosphor Bronze	
Contact Current Rating (Max)	1 A	
Termination Features		
Rectangular Termination Post & Tail Thickness	.32 mm[.013 in]	
Rectangular Termination Post & Tail Width	.5 mm[.02 in]	
Termination Post & Tail Length	3.94 mm[.155 in]	
Termination Method to Wire & Cable	Insulation Displacement (IDC)	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	With	
PCB Mount Alignment	Without	
Panel Mount Feature	Without	
PCB Mount Retention	Without	
Mating Alignment Type	Polarization	
Mating Retention	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Housing Material	Thermoplastic	
Centerline (Pitch)	2.54 mm[.1 in]	
Dimensions		
Connector Length	27.64 mm[1.088 in]	
Connector Height	6.43 mm[.253 in]	

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Connector Width	10.67 mm[.42 in]	
Wire Size	.051 – .15 mm²	
PCB Thickness (Recommended)	3.18 mm[.125 in]	
Compatible Insulation Diameter Range	.81 – 1.07 mm[.032 – .042 in]	
Row-to-Row Spacing	2 mm[.3 in]	
Usage Conditions		
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Solder Process Feature	Solder Dipped	
Circuit Application	Signal	
Industry Standards		
UL Rating	Recognized	
Agency/Standard	CSA, UL	
Approved Standards	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	120	

Product Compliance

For compliance documentation, visit the product page on TE.com>

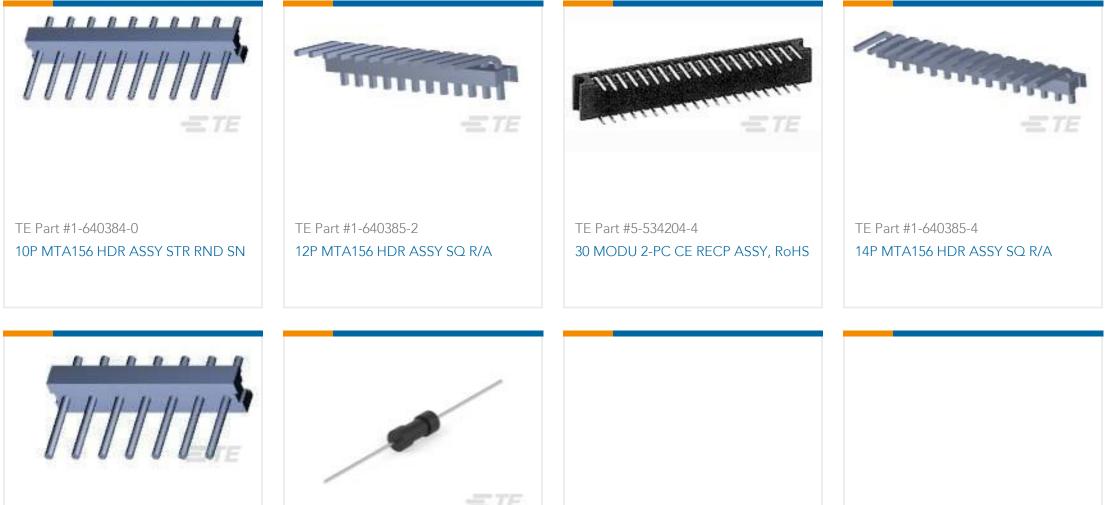
EU RoHS Directive 2011/65/EU	Compliant		
EU ELV Directive 2000/53/EC	Compliant		
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold		
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC		
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.		
Solder Process Capability	Wave solder capable to 265°C		
Product Compliance Disclaimer			

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Customers Also Bought



	and find		
TE Part #640384-7	TE Part #2176471-2	TE Part #R-13185-3	TE Part #R-13184-3
07P MTA156 HDR ASSY STR RND SN	HPCR 0819 A 10% 6R8 Std T&R	RTD,ASSY,TTF,P100,385,.1%,TR2	RTD,BRG,ASY,P100,385,.1%,.375D

Documents

Product Drawings 20 DIP PLUG CONN-W/COVER

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_1-746611-0_G.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-746611-0_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-746611-0_G.3d_stp.zip

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English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Ribbon Cable Interconnect Solutions

English

Product Specifications Application Specification

English

Instruction Sheets Instruction Sheet (U.S.)

English

Agency Approvals UL Report

English